



Customer Information Notification

201809015IU01

Issue Date: 08-Nov-2018
Effective Date: 07-Dec-2018

UPDATE

Here's your personalized quality information concerning products Digi-Key purchased from NXP.
For detailed information we invite you to view this notification online



QUALITY

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

i.MX6ULL and i.MX6UltraLite Final Test Site Expansion from NXP-ATTJ to KESM Tianjin, China

Description

NXP Semiconductors announces the Final Test site expansion for the i.MX6ULL and i.MX6UltraLite product associated with this notification, from the current NXP-ATTJ Tianjin, China Final Test site to the KESM Tianjin, China Final Test site.

Final Test site transfer was successfully qualified adhering to NXP specifications.

Reason

Qualification of KESM Tianjin, China is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Update Information

This Update Notice is to extend the Effective date to 7th December 2018.

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

NXP will reserve the right to ship from any location based on market demand situation.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Affected Part Numbers

MCIMX6Y2DVM05AA
MCIMX6Y1CVM05AB
MCIMX6G3DVM05AA
MCIMX6Y2CVM05AA
MCIMX6G2DVM05AA
MCIMX6Y1CVM05AA
MCIMX6G2CVK05AA
MCIMX6Y7DVK05AA
MCIMX6G2DVK05AA
MCIMX6Y1CVK05AA
MCIMX6Y1DVK05AA
MCIMX6Y2CVM08AA
MCIMX6Y2DVM09AA
MCIMX6Y7DVM09AA
MCIMX6G1CVM05AB
MCIMX6G2CVM05AB
MCIMX6G2DVM05AB
MCIMX6G3CVM05AB
MCIMX6G3DVM05AB